Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2419	semiconductor with interposer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/21 08:59
L2	1235	resist with remov\$5 with laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/21 09:00
L3	6	1 and 2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/21 08:57
L4	341281	semiconductor with (resin plastic insulat\$4 glass ceramic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/21 09:00
L5	352	2 and 4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/21 08:59
L6	917	(resist near5 remov\$5) with laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/21 09:00
L7	297	4 and 6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/21 09:00
L8	96628	semiconductor with surface with (resin plastic insulat\$4 glass ceramic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/21 09:01
L9	181	6 and 8	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/21 09:01
L10	8	6 same 8	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/21 09:22

L11	1	("5950071").PN.	USPAT;	OR	OFF	2005/12/21 09:22
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